1.5 A, Very Low-Dropout (VLDO) Fast Transient Response Regulator Series

NCP59150, NCV59150 Series

The NCP59150 series are high precision, very low dropout (VLDO), low ground current positive voltage regulators that are capable of providing an output current in excess of 1.5 A with a typical dropout voltage lower than 300 mV at 1.5 A load current. The devices are stable with ceramic output capacitors. This series consists of Adjustable output voltage and fixed voltage versions.

The NCP59150 series can withstand up to 18 V max input voltage.

Internal protection features consist of output current limiting, built−in thermal shutdown and reverse output current protection. Logic level enable and error flag pins are available on the 5−pin and 8−pin versions.

The NCP59150 series Adjustable Voltage devices are available in D2PAK−5 and DFN8 packages, the Fixed Voltage option are available in D^{2}PAK−5, D^{2}PAK−3 and DFN8 packages.

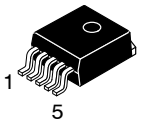
Features

- Output Current in Excess of 1.5 A
- 300 mV Typical Dropout Voltage at 1.5 A
- Adjustable and Fixed Output Voltage Options
- Low Ground Current
- Fast Transient Response
- Stable with Ceramic Output Capacitor
- Logic Compatible Enable and Error Flag Pins
- Current Limit, Reverse Current and Thermal Shutdown Protection
- Operation up to 13.5 V Input Voltage
- NCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC−Q100 Qualified and PPAP Capable
- These are Pb−Free Devices

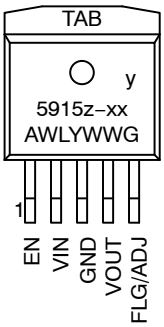
Applications

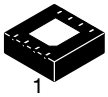
- Consumer and Industrial Equipment Point of Regulation
- Servers and Networking Equipment
- FPGA, DSP and Logic Power Supplies
- Switching Power Supply Post Regulation
- Battery Chargers
- Functional Replacement for Industry Standard MIC29150, MIC39150, MIC37150

MARKING DIAGRAMS



D^{2}PAK−5
CASE 936A





DFN8
CASE 488AF

xx	= Voltage Version
y	= P (NCP), V (NCV)
z	= 1 (Fix Voltage), 2 (Adj)
A	= Assembly Location
L, WL	= Wafer Lot
Y	= Year
W, WW	= Work Week
G, ▪	= Pb−Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 9 of this data sheet.

NOTE: Some of the devices on this data sheet have been **DISCONTINUED**. Please refer to the table on page 9.

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TYPICAL APPLICATIONS

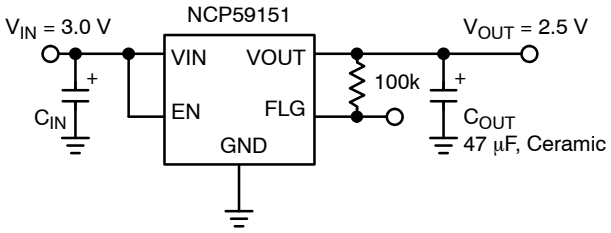


Figure 1. Fixed 2.5 Regulator with Error Flag

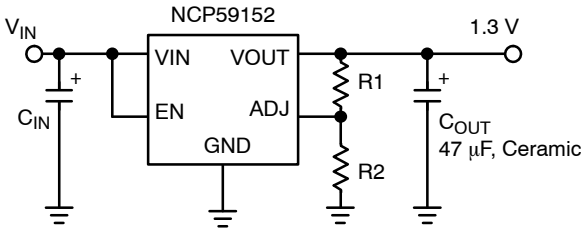


Figure 2. Adjustable Regulator

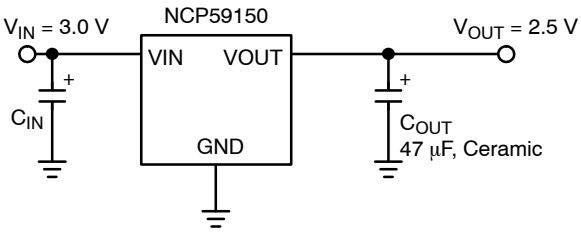


Figure 3. Fixed 2.5 Regulator in D^2PAK−3 Package

PIN FUNCTION DESCRIPTION

Pin Number D2PAK−5	Pin Number D2PAK−3	Pin Number DFN8	Pin Name	Pin Function
1	−	2	EN	Enable Input: CMOS and TTL logic compatible. Logic high = enable; Logic low = shutdown.
2	1	3	VIN	Input voltage which supplies both the internal circuitry and the current to the output load.
3	2	1	GND	Ground
TAB	TAB	−	TAB	TAB is connected to ground.
4	3	6	VOUT	Linear Regulator Output.
5 (Fixed)	−	8	FLG	Error Flag Open collector output. Active−low indicates an output fault condition.
5 (Adj)	−	7 (Adj)	ADJ	Adjustable Regulator Feedback Input. Connect to output voltage resistor divider central node.
−	−	7 (Fixed)	VOUT SENSE	Fixed Voltage Regulator Feedback Input. Connect to output voltage node.
−	−	EP	EXPOSED PAD	PAD for removing heat from the device. Must be connected to GND.
−	−	4, 5	NC	Not internally connected.

ABSOLUTE MAXIMUM RATINGS

Symbol	Rating	Value	Unit
V_{IN}	Supply Voltage	0 to 18	V
V_{EN}	Enable Input Voltage	0 to 18	V
V_{FLG}	Error Flag Open Collector Output Maximum Voltage	0 to 18	V
$V_{OUT} - V_{IN}$	Reverse $V_{OUT} - V_{IN}$ Voltage (EN = Shutdown or Vin = 0 V) (Note 1)	0 to 6.5	V
P_D	Power Dissipation (Notes 2 and 5)	Internally Limited	
T_J	Junction Temperature	$-40 \le T_J \le +125$	°C
T_S	Storage Temperature	$-65 \le T_J \le +150$	°C
	ESD Rating (Notes 3 and 4) Human Body Model Machine Model	2000 200	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

NOTE: All voltages are referenced to GND pin unless otherwise noted.

1. The ENABLE pin input voltage must be ≤ 0.8 V or Vin must be connected to ground potential.
2. $P_{D(max)} = (T_{J(max)} - T_A) / R_{\theta JA}$, where $R_{\theta JA}$ depends upon the printed circuit board layout.
3. Devices are ESD sensitive. Handling precautions recommended..
4. This device series incorporates ESD protection and is tested by the following methods:
   ESD Human Body Model (HBM) tested per AEC−Q100−002 (EIA/JESD22−A114C)
   ESD Machine Model (MM) tested per AEC−Q100−003 (EIA/JESD22−A115C)
   This device contains latch−up protection and exceeds 100 mA per JEDEC Standard JESD78.
5. This protection is not guaranteed outside the Recommended Operating Conditions.

RECOMMENDED OPERATING CONDITIONS (Note 6)

Symbol	Rating	Value	Unit
V_{IN}	Supply Voltage	2.24 to 13.5	V
V_{EN}	Enable Input Voltage	0 to 13.5	V
V_{FLG}	Error Flag Open Collector Voltage	0 to 13.5	V
T_J	Junction Temperature	$-40 \le T_J \le +125$	°C

6. The device is not guaranteed to function outside it's Recommended operating conditions.

ELECTRICAL CHARACTERISTICS

T_J = 25°C with V_{IN} = $V_{OUT\ nominal}$ + 1 V; V_{EN} = V_{IN}; I_L = 10 mA; bold values indicate −40°C < T_J < +125°C, unless noted.

Parameter	Conditions	Min	Typ	Max	Unit
Output Voltage Accuracy DFN package	I_L = 10 mA	−1		1	%
	10 mA < I_{OUT} < 1.5 A , $V_{OUT\ nominal}$ + 1 ≤ V_{IN} ≤ 13.5 V	**−2**		**2**	%
Output Voltage Accuracy D2PAK package	IL = 10 mA	−1.5		1.5	%
	10 mA < I_{OUT} < 1.5 A , $V_{OUT\ nominal}$ + 1 ≤ V_{IN} ≤ 13.5 V	**−2.5**		**2.5**	%
Output Voltage Line Regulation	V_{IN} = $V_{OUT\ nominal}$ + 1.0 V to 13.5 V; I_L = 10 mA		0.02	0.5	%
Output Voltage Load Regulation	I_L = 10 mA to 1.5 A		0.2	1.0	%
V_{IN} − V_{OUT} Dropout Voltage (Note 7)	I_L = 750 mA		175	**350**	mV
	I_L = 1.5 A		300	**500**	mV
Ground Pin Current (Note 8)	I_L = 1.5 A		40	60 **80**	mA
Ground Pin Current in Shutdown	V_{EN} ≤ 0.5 V		1.0	5.0	μA
Overload Protection Current Limit	V_{OUT} = 0 V		2.0	**3.0**	A
Start−up Time	V_{EN} = V_{IN}, V_{OUT} nominal = 2.5 V, I_{OUT} = 10 mA, C_{OUT} = 47 μF		100	500	μs
Output Voltage Start−up Slope Fixed Voltage Devices	V_{EN} = V_{IN}, I_{OUT} = 10 mA, C_{OUT} = 47 μF (Note 9)		40	200	μs/V
ENABLE INPUT					
Enable Input Signal Levels	Regulator Enable	**1.8**			V
	Regulator Shutdown			**0.8**	V
Enable Pin Input Current	V_{EN} ≤ 0.8 V (Regulator Shutdown)			2.0 **4.0**	μA
	6.5 V > V_{EN} ≥ 1.8 V (Regulator enable)	1.0	15	30 **40**	μA
FLAG OUTPUT					
$I_{FLG(leak)}$	V_{oh} = 13.5 V, Flag OFF			1.0 **2.0**	μA
$V_{FLG(LO)}$	V_{IN} = 2.24 V, I_{FLG} = 1 mA, Flag ON		210	400 **500**	mV
V_{FLG}	Low Threshold, % of particular V_{OUT}	93	95		%
	Hysteresis, % of particular V_{OUT}		2		%
	High Threshold, % of particular V_{OUT}		97	99.2	%
NCP/NCV59152 ADJ VOLTAGE DEVICES ONLY					
Reference Voltage DFN Package D^{2}PAK Package		1.228 **1.215** 1.221 **1.209**	1.240 1.240	1.252 **1.265** 1.259 **1.271**	V
Adjust Pin Bias Current			100	200 **350**	nA

7. V_{DO} = V_{IN} − V_{OUT} when V_{OUT} decreases to 98% of its nominal output voltage with V_{IN} = V_{OUT} + 1 V. For output voltages below 1.74 V, dropout voltage specification does not apply due to a minimum input operating voltage of 2.24 V.
8. I_{IN} = I_{GND} + I_{OUT}.
9. Fixed Voltage Device Start−up Time = Output Voltage Start−up Slope * V_{OUT} nominal.

Package	Conditions / PCB Footprint	Thermal Resistance
D2PAK−3, Junction−to−Case		$R_{\theta JC}$ = 2.1°C/W
D2PAK−5, Junction−to−Case		$R_{\theta JC}$ = 2.1°C/W
D2PAK−3, Junction−to−Air	PCB with 100 mm^2 2.0 oz Copper Heat Spreading Area	$R_{\theta JA}$ = 52°C/W
D2PAK−5, Junction−to−Air	PCB with 100 mm^2 2.0 oz Copper Heat Spreading Area	$R_{\theta JA}$ = 52°C/W
DFN8, Junction−to−Air	PCB with 500 mm^2 2.0 oz Copper Heat Spreading Area	$R_{\theta JA}$ = 75°C/W

TYPICAL CHARACTERISTICS

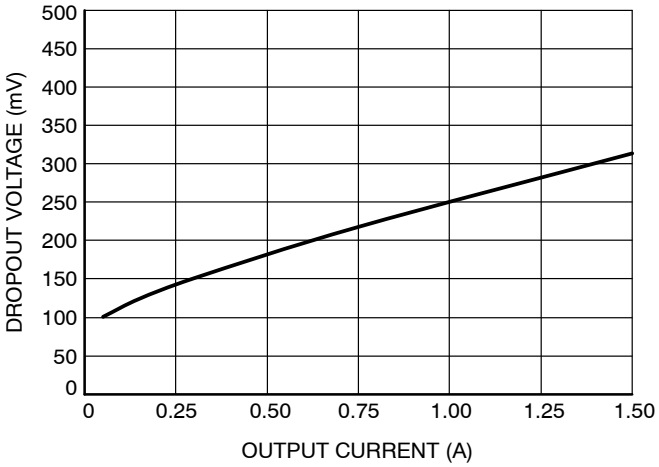


Figure 4. Dropout Voltage vs. Output Current (V_{OUTnom} = 2.5 V)

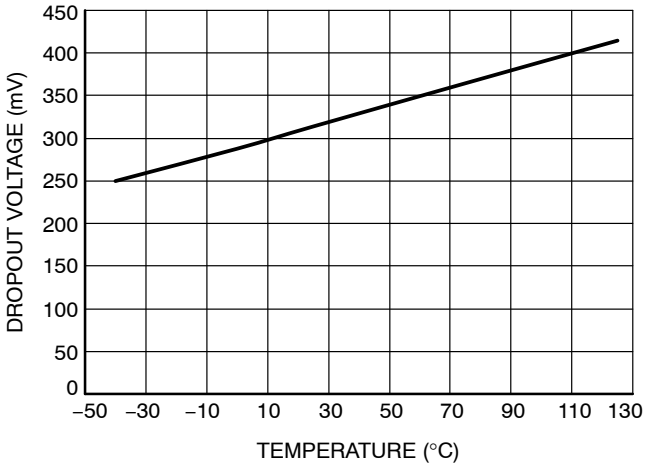


Figure 5. Dropout Voltage vs. Temperature (V_{OUTnom} = 2.5 V, I_{OUT} = 1.5 A)

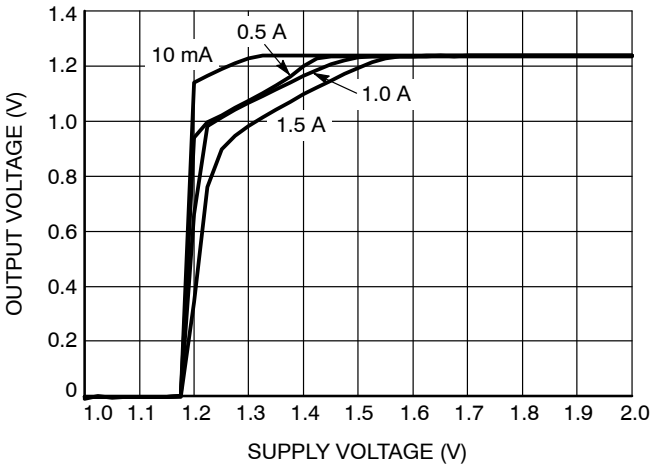


Figure 6. Dropout Characteristics (V_{OUTnom} = 1.24 V)

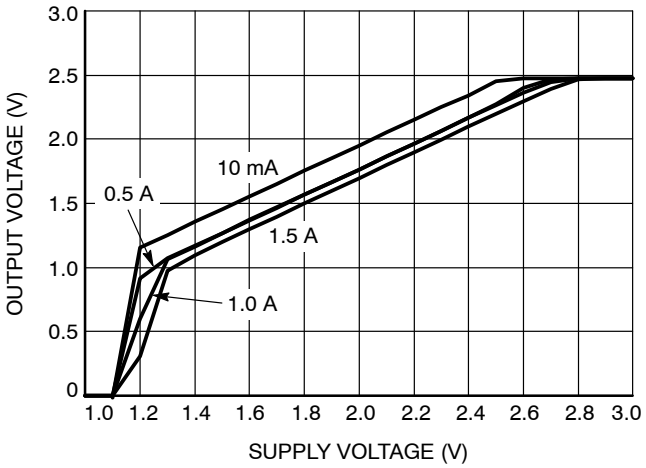


Figure 7. Dropout Characteristics (V_{OUTnom} = 2.5 V)

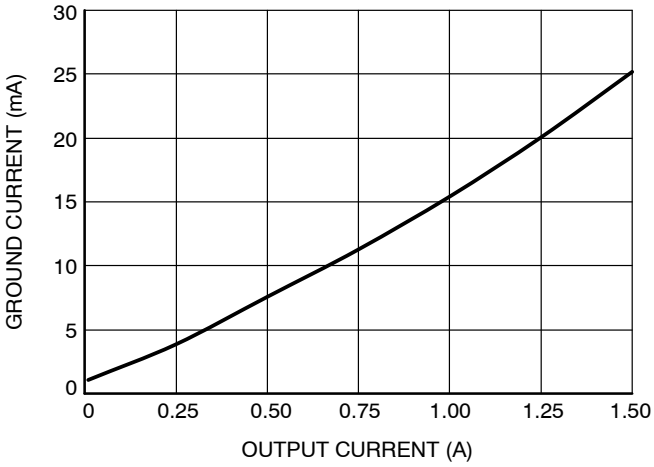


Figure 8. Ground Current vs. Output Current (V_{OUTnom} = 1.24 V)

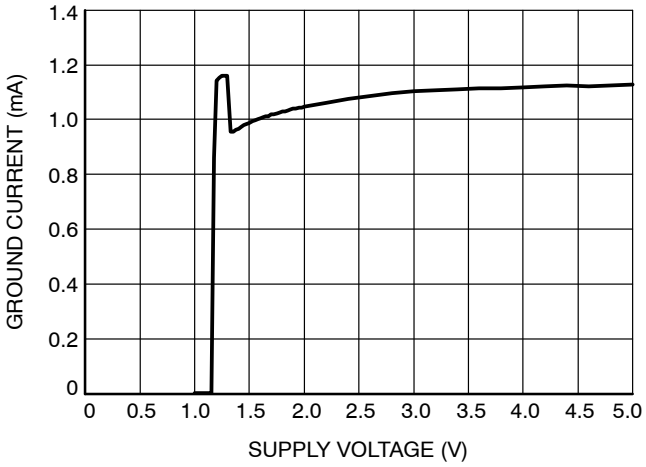


Figure 9. Ground Current vs. Supply Voltage (V_{OUTnom} = 1.24 V, I_{OUT} = 10 mA)

TYPICAL CHARACTERISTICS

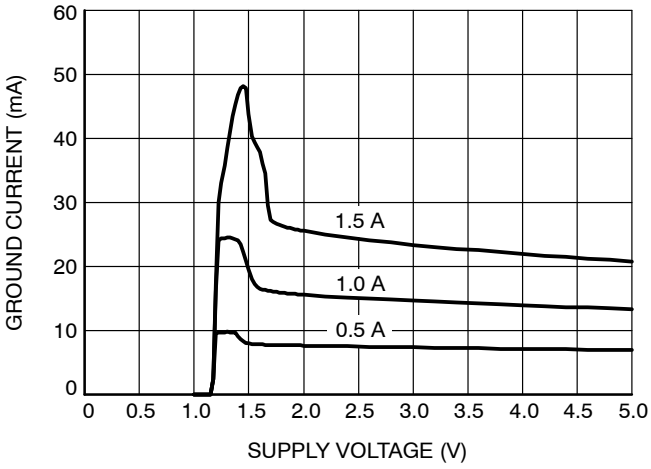


Figure 10. Ground Current vs. Supply Voltage (V_{OUTnom} = 1.24 V)

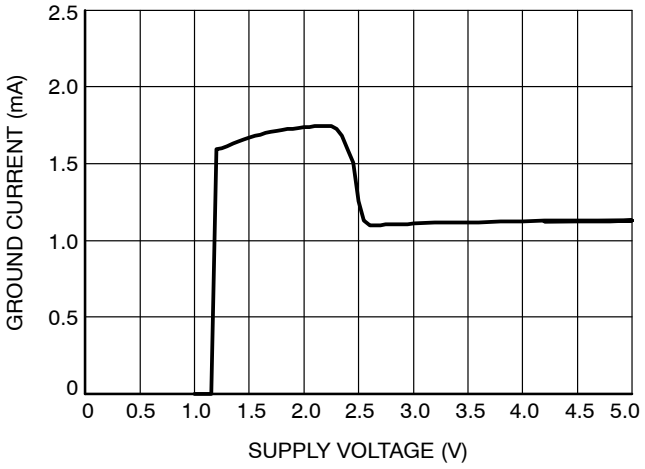


Figure 11. Ground Current vs. Supply Voltage (V_{OUTnom} = 2.5 V, I_{OUT} = 10 mA)

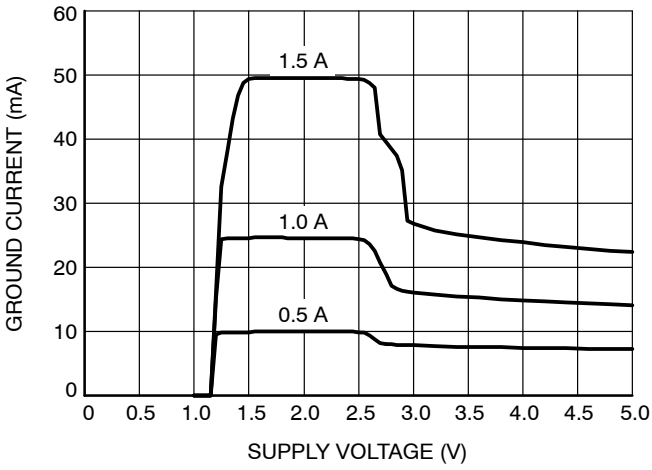


Figure 12. Ground Current vs. Supply Voltage (V_{OUTnom} = 2.5 V)

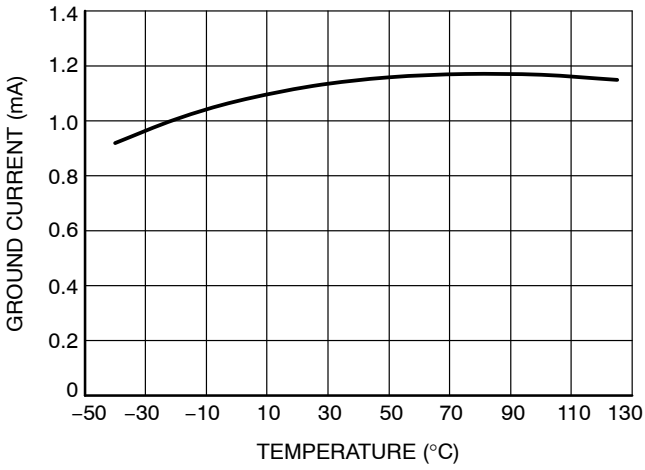


Figure 13. Ground Current vs. Temperature (V_{OUTnom} = 2.5 V, I_{OUT} = 10 mA, V_{IN} = 3.5 V)

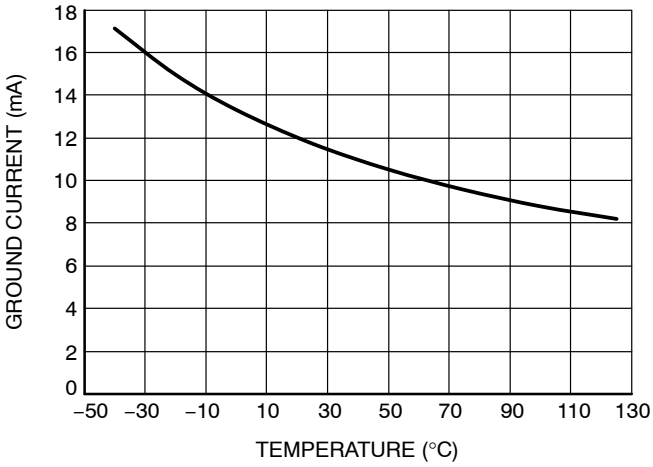


Figure 14. Ground Current vs. Temperature (V_{OUTnom} = 2.5 V, I_{OUT} = 0.75 A, V_{IN} = 3.5 V)

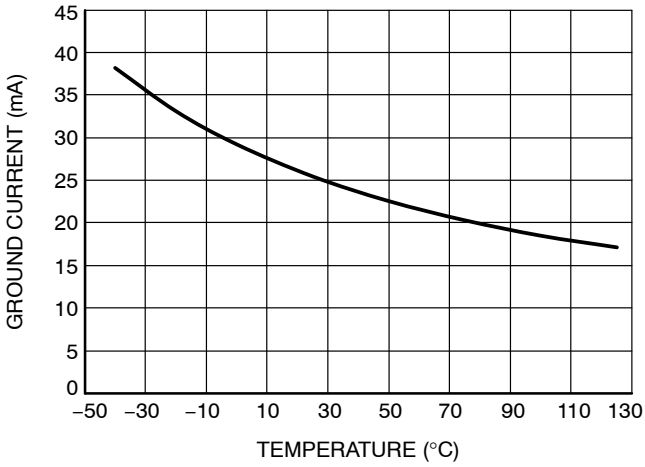


Figure 15. Ground Current vs. Temperature (V_{OUTnom} = 2.5 V, I_{OUT} = 1.5 A, V_{IN} = 3.5 V)

TYPICAL CHARACTERISTICS

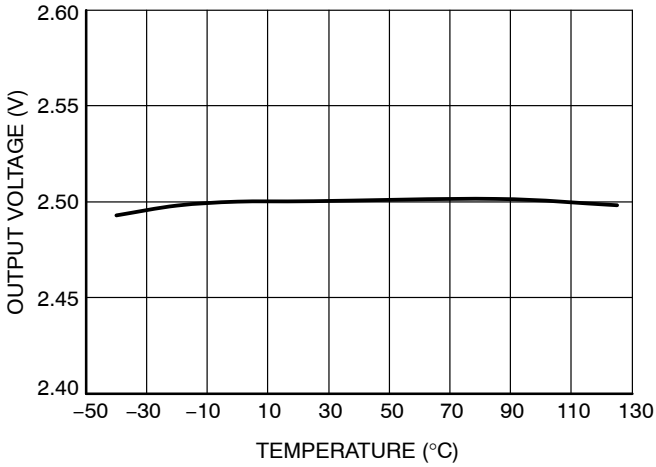


Figure 16. Output Voltage vs. Temperature (V_{OUTnom} = 2.5 V, I_{OUT} = 10 mA)

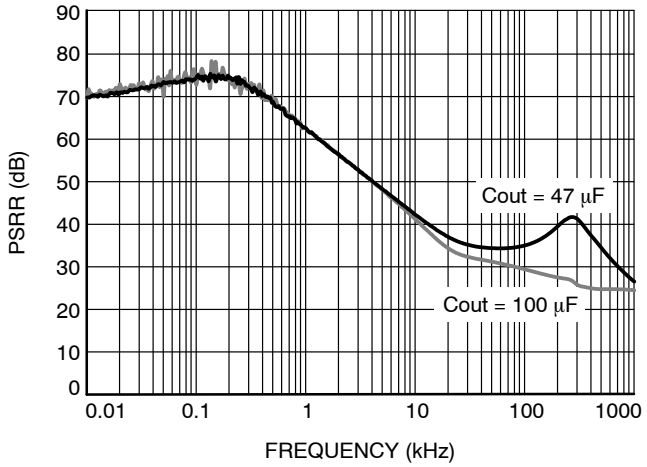


Figure 17. PSRR vs. Frequency, Vin = 3.5 V + 200 mVpp Modulation, Vout = 2.5 V, Iout = 0.5 A

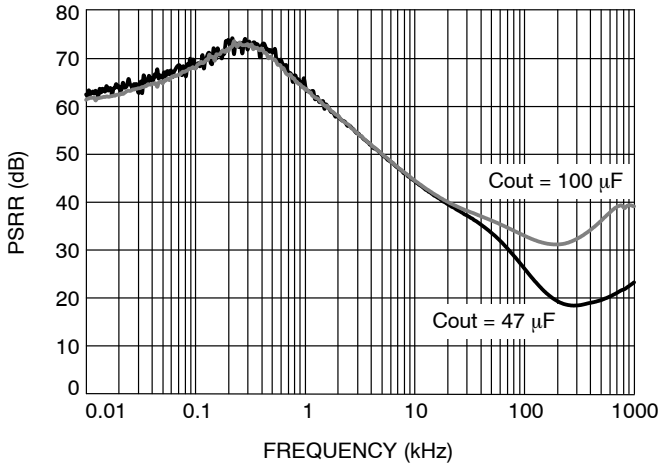


Figure 18. PSRR vs. Frequency, Vin = 3.5 V + 200 mVpp Modulation, Vout = 2.5 V, Iout = 1.5 A

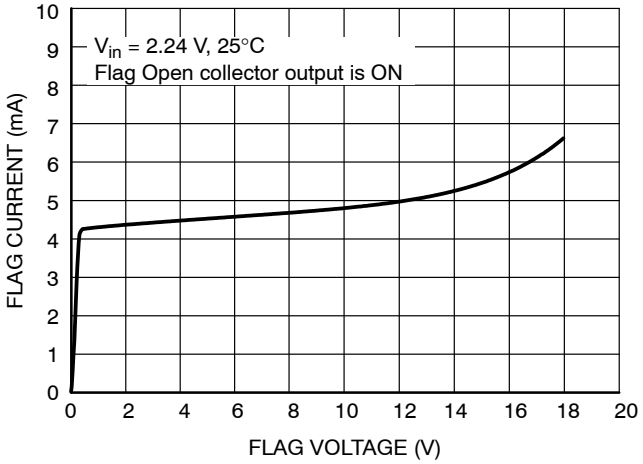


Figure 19. Flag Current vs. Flag Voltage

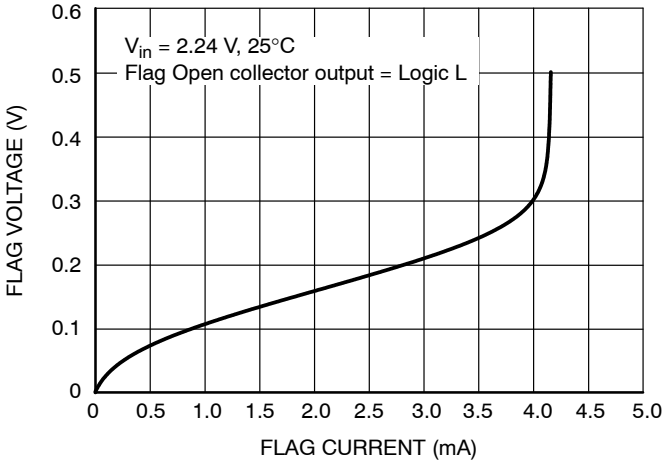


Figure 20. Flag Voltage vs. Flag Current

TYPICAL CHARACTERISTICS

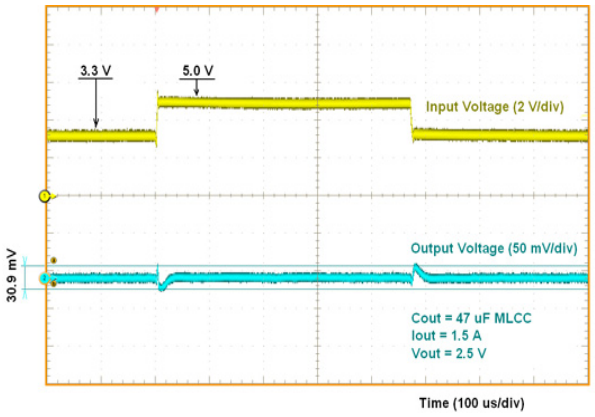


Figure 21. Line Transient Response

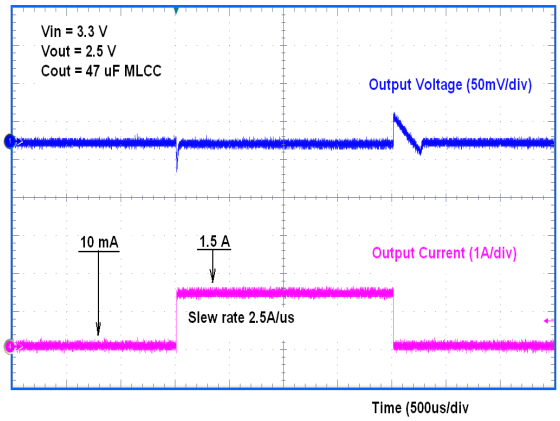


Figure 22. Load Transient Response

APPLICATIONS INFORMATION

Output Capacitor and Stability

The NCP59150 series requires an output capacitor for stable operation. The NCP59150 series is designed to operate with ceramic output capacitors. The recommended output capacitance value is 47 μF or greater. Such capacitors help to improve transient response and noise reduction at high frequency.

Input Capacitor

An input capacitor of 1.0 μF or greater is recommended when the device is more than 4 inches away from the bulk supply capacitance, or when the supply is a battery. Small, surface−mount chip capacitors can be used for the bypassing. The capacitor should be place within 1 inch of the device for optimal performance. Larger values will help to improve ripple rejection by bypassing the input of the regulator, further improving the integrity of the output voltage.

Minimum Load Current

The NCP59150 regulator is specified between finite loads. A 5 mA minimum load current is necessary for proper operation.

Error Flag

Some NCP59150 series members feature an error flag circuit that monitors the output voltage and signals an error condition when the voltage is 5% below the nominal output voltage. The error flag is an open−collector output that can sink up to 5 mA typically during a V_{OUT} fault condition.

The FLG output is overload protected when a short circuit of the pullup load resistor occurs in the application. This is guaranteed in the full range of FLG output voltage Max ratings (see Max Ratings table). Please be aware operation in this mode is not recommended, power dissipated in the device can impact on output voltage precision and other device characteristics.

Enable Input

Some NCP59150 series members also feature an enable input for on/off control of the device. It's shutdown state draws "zero" current from input voltage supply (only microamperes of leakage). The enable input is TTL/CMOS compatible for simple logic interface, but can be connected up to V_{IN}.

Overcurrent and Reverse Output Current Protection

The NCP59150 regulator is fully protected from damage due to output current overload and output short conditions. When NCP59150 output is overloaded, Output Current limiting is provided. This limiting is linear; output current during overload or output short conditions is constant. These features are advantageous for powering FPGAs and other ICs having current consumption higher than nominal during their startup.

Thermal shutdown disables the NCP59150 device when the die temperature exceeds the maximum safe operating temperature.

When NCP59150 is disabled and (V_{OUT} – V_{IN}) voltage difference is less than 6.5 V in the application, the output structure of these regulators is able to withstand output voltage (backup battery as example) to be applied without reverse current flow. Of course the additional current flowing through the feedback resistor divider inside the Fixed Voltage devices (30 μA typically at nominal output voltage) needs to be included in the backup battery discharging calculations.

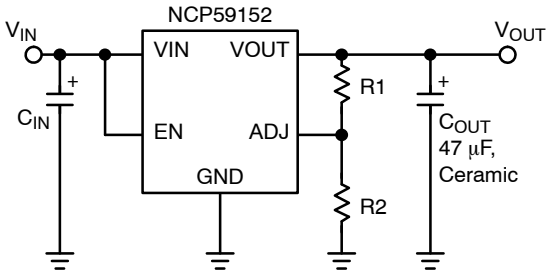
Adjustable Voltage Design

The NCP/NCV59152 Adjustable voltage Device Output voltage is set by the ratio of two external resistors as shown in Figure 23.

The device maintains the voltage at the ADJ pin at 1.24 V referenced to ground. The current in R2 is then equal to

1.24 V / R2, and the current in R1 is the current in R2 plus the ADJ pin bias current. The ADJ pin bias current flows from V_{OUT} through R1 into the ADJ pin.

The output voltage can be calculated using the formula shown in Figure 23.



$$V_{OUT} = 1.24\ V \cdot \left(1 + \frac{R1}{R2}\right) + I_{ADJ} \cdot R1$$

Figure 23. Adjustable Voltage Operation

Thermal Considerations

The power handling capability of the device is limited by the maximum rated junction temperature (125°C). The P_D total power dissipated by the device has two components, Input to output voltage differential multiplied by Output current and Input voltage multiplied by GND pin current.

$$P_D = \left(V_{IN} - V_{OUT}\right) \cdot I_{OUT} + V_{IN} \cdot I_{GND} \quad \text{(eq. 1)}$$

The GND pin current value can be found in Electrical Characteristics table and in Typical Characteristics graphs. The Junction temperature T_J is

$$T_J = T_A + P_D \cdot R_{\theta JA} \quad \text{(eq. 2)}$$

where T_A is ambient temperature and $R_{\theta JA}$ is the Junction to Ambient Thermal Resistance of the NCP/NCV59150 device mounted on the specific PCB.

To maximize efficiency of the application and minimize thermal power dissipation of the device it is convenient to use the Input to output voltage differential as low as possible.

The static typical dropout characteristics for various output voltage and output current can be found in the Typical Characteristics graphs.

ORDERING INFORMATION

Device	Output Current	Output Voltage	Junction Temp. Range	Package	Shipping†
NCP59151MN50TYG	1.5 A	5.0 V	−40°C to +125°C	DFN8−4x4 (Pb−Free)	4000 / Tape & Reel
NCV59151MN25TYG	1.5 A	2.5 V	−40°C to +125°C	DFN8−4x4 (Pb−Free)	4000 / Tape & Reel
NCP59152DSADJR4G	1.5 A	ADJ	−40°C to +125°C	D2PAK−5 (Pb−Free)	800 / Tape & Reel

DISCONTINUED (Note 10)

NCP59151DS18R4G	1.5 A	1.8 V	−40°C to +125°C	D²PAK−5 (Pb−Free)	800 / Tape & Reel
NCP59151DS25R4G	1.5 A	2.5 V	−40°C to +125°C	D²PAK−5 (Pb−Free)	800 / Tape & Reel
NCP59151DS28R4G	1.5 A	2.8 V	−40°C to +125°C	D²PAK−5 (Pb−Free)	800 / Tape & Reel
NCP59151DS30R4G	1.5 A	3.0 V	−40°C to +125°C	D²PAK−5 (Pb−Free)	800 / Tape & Reel
NCP59151DS33R4G	1.5 A	3.3 V	−40°C to +125°C	D²PAK−5 (Pb−Free)	800 / Tape & Reel
NCP59151DS50R4G	1.5 A	5.0 V	−40°C to +125°C	D²PAK−5 (Pb−Free)	800 / Tape & Reel
NCV59151DS18R4G*	1.5 A	1.8 V	−40°C to +125°C	D²PAK−5 (Pb−Free)	800 / Tape & Reel
NCV59151DS25R4G*	1.5 A	2.5 V	−40°C to +125°C	D²PAK−5 (Pb−Free)	800 / Tape & Reel
NCV59151DS28R4G*	1.5 A	2.8 V	−40°C to +125°C	D²PAK−5 (Pb−Free)	800 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*NCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC−Q100 Qualified and PPAP Capable

ORDERING INFORMATION (continued)

Device	Output Current	Output Voltage	Junction Temp. Range	Package	Shipping†
DISCONTINUED (Note 10)					
NCV59151DS30R4G*	1.5 A	3.0 V	−40°C to +125°C	D^2PAK−5 (Pb−Free)	800 / Tape & Reel
NCV59151DS33R4G	1.5 A	3.3 V	−40°C to +125°C	D^2PAK−5 (Pb−Free)	800 / Tape & Reel
NCV59151DS50R4G	1.5 A	5.0 V	−40°C to +125°C	D^2PAK−5 (Pb−Free)	800 / Tape & Reel
NCP59151MN18TYG	1.5 A	1.8 V	−40°C to +125°C	DFN8−4x4 (Pb−Free)	4000 / Tape & Reel
NCP59151MN25TYG	1.5 A	2.5 V	−40°C to +125°C	DFN8−4x4 (Pb−Free)	4000 / Tape & Reel
NCP59151MN28TYG	1.5 A	2.8 V	−40°C to +125°C	DFN8−4x4 (Pb−Free)	4000 / Tape & Reel
NCP59151MN30TYG	1.5 A	3.0 V	−40°C to +125°C	DFN8−4x4 (Pb−Free)	4000 / Tape & Reel
NCP59151MN33TYG	1.5 A	3.3 V	−40°C to +125°C	DFN8−4x4 (Pb−Free)	4000 / Tape & Reel
NCV59151MN18TYG	1.5 A	1.8 V	−40°C to +125°C	DFN8−4x4 (Pb−Free)	4000 / Tape & Reel
NCV59151MN28TYG	1.5 A	2.8 V	−40°C to +125°C	DFN8−4x4 (Pb−Free)	4000 / Tape & Reel
NCV59151MN30TYG	1.5 A	3.0 V	−40°C to +125°C	DFN8−4x4 (Pb−Free)	4000 / Tape & Reel
NCV59151MN33TYG	1.5 A	3.3 V	−40°C to +125°C	DFN8−4x4 (Pb−Free)	4000 / Tape & Reel
NCV59151MN50TYG	1.5 A	5.0 V	−40°C to +125°C	DFN8−4x4 (Pb−Free)	4000 / Tape & Reel
NCP59152MNADJTYG	1.5 A	ADJ	−40°C to +125°C	DFN8−4x4 (Pb−Free)	4000 / Tape & Reel
NCV59152MNADJTYG	1.5 A	ADJ	−40°C to +125°C	DFN8−4x4 (Pb−Free)	4000 / Tape & Reel
NCV59152DSADJR4G	1.5 A	ADJ	−40°C to +125°C	D2PAK−5 (Pb−Free)	800 / Tape & Reel

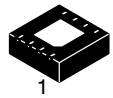
†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*NCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC−Q100 Qualified and PPAP Capable

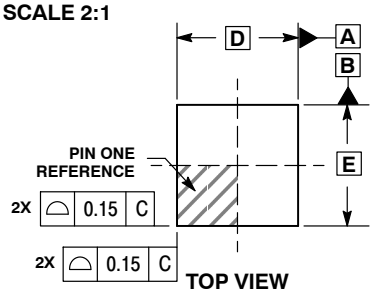
10. **DISCONTINUED:** These devices are not recommended for new design. Please contact your **onsemi** representative for information. The most current information on these devices may be available on www.onsemi.com.

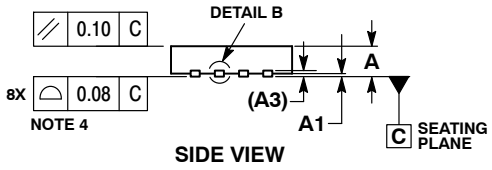
DFN8, 4x4
CASE 488AF
ISSUE C

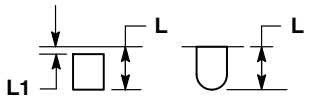
DATE 15 JAN 2009

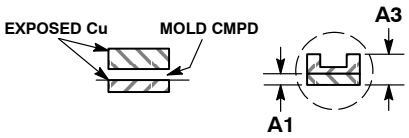


SCALE 2:1



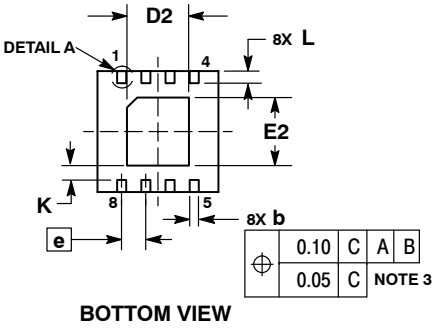




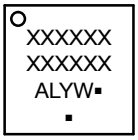


NOTES:
1. DIMENSIONS AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30MM FROM TERMINAL TIP.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.
5. DETAILS A AND B SHOW OPTIONAL CONSTRUCTIONS FOR TERMINALS.

	MILLIMETERS	
DIM	MIN	MAX
A	0.80	1.00
A1	0.00	0.05
A3	0.20 REF	
b	0.25	0.35
D	4.00 BSC	
D2	1.91	2.21
E	4.00 BSC	
E2	2.09	2.39
e	0.80 BSC	
K	0.20	---
L	0.30	0.50
L1	---	0.15



GENERIC MARKING DIAGRAM*

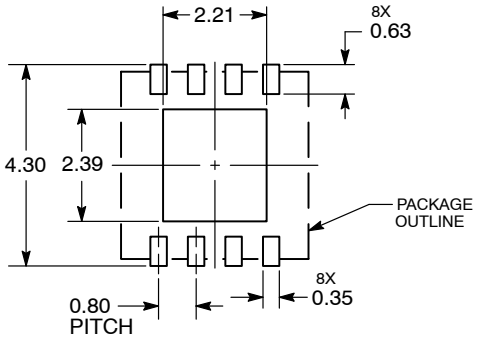


XXXX = Specific Device Code
A = Assembly Location
L = Wafer Lot
Y = Year
W = Work Week
▪ = Pb−Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb−Free indicator, “G” or microdot “ ▪”, may or may not be present.

SOLDERING FOOTPRINT*



DIMENSIONS: MILLIMETERS

*For additional information on our Pb−Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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DESCRIPTION:	**DFN8, 4X4, 0.8P**	**PAGE 1 OF 1**

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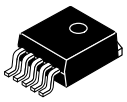

D²PAK 5–LEAD
CASE 936A–02
ISSUE E

DATE 28 JUL 2021

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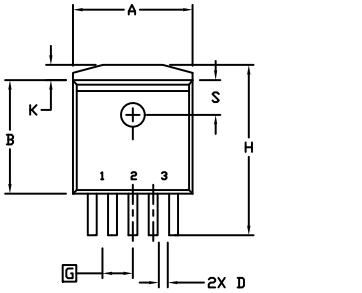
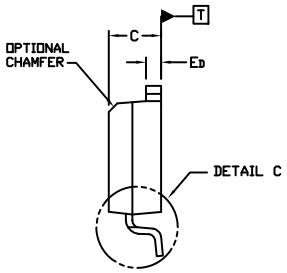
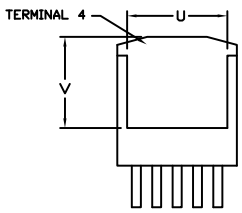


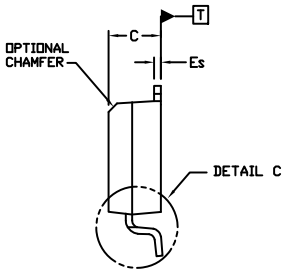
TOP VIEW



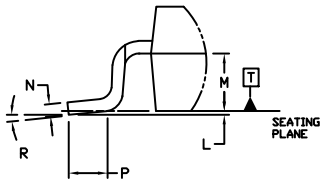
SIDE VIEW
DUAL GUAGE CONSTRUCTION



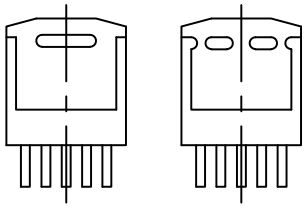
BOTTOM VIEW



SIDE VIEW
SINGLE GUAGE CONSTRUCTION



DETAIL C
TIP LEADFORM
ROTATED 90° CW



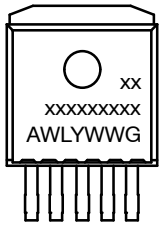
BOTTOM VIEW
OPTIONAL CONSTRUCTIONS

NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCHES
3. TAB CONTOUR OPTIONAL WITHIN DIMENSIONS A AND K.
4. DIMENSIONS U AND V ESTABLISH A MINIMUM MOUNTING SURFACE FOR TERMINAL 4.
5. DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH OR GATE PROTRUSIONS. MOLD FLASH AND GATE PROTRUSIONS NOT TO EXCEED 0.025 (0.635) MAXIMUM.

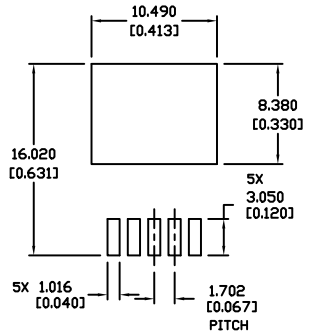
DIM	INCHES		MILLIMETERS	
	MIN.	MAX.	MIN.	MAX.
A	0.396	0.403	9.804	10.236
B	0.356	0.368	9.042	9.347
C	0.170	0.180	4.318	4.572
D	0.026	0.036	0.660	0.914
ED	0.045	0.055	1.143	1.397
ES	0.018	0.026	0.457	0.660
G	0.067 BSC		1.702 BSC	
H	0.539	0.579	13.691	14.707
K	0.050 REF		1.270 REF	
L	0.000	0.010	0.000	0.254
M	0.088	0.102	2.235	2.591
N	0.018	0.026	0.457	0.660
P	0.058	0.078	1.473	1.981
R	0°	8°	0°	8°
S	0.116 REF		2.946 REF	
U	0.200 MIN		5.080 MIN	
V	0.250 MIN		6.350 MIN	

GENERIC MARKING DIAGRAM*



XXXXXX	= Device Code
A	= Assembly Location
WL	= Wafer Lot
Y	= Year
WW	= Work Week
G	= Pb–Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb–Free indicator, “G” or microdot “▪”, may or may not be present. Some products may not follow the Generic Marking.



RECOMMENDED
MOUNTING FOOTPRINT *

* For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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DESCRIPTION:	**D2PAK 5–LEAD**		**PAGE 1 OF 1**

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